

TECHNICAL DATA DATA SHEET 816, REV. -

HERMETIC POWER MOSFET N-CHANNEL, LOGIC LEVEL

- 60 VOLT, 0.05 OHM, 30A MOSFET
- Fast Switching
- Low R_{DS (on)}
- Logic Level Gate Driver

MAXIMUM RATINGS

ALL RATINGS ARE AT $T_A = 25^{\circ}$ C UNLESS OTHERWISE SPECIFIED.

RATING	SYMBOL	MIN.	TYP.	MAX.	UNITS
GATE TO SOURCE VOLTAGE	V_{GS}	-	-	±20	Volts
CONTINUOUS DRAIN CURRENT @ T _C = 25°C	I _D	-	-	20*	Amps
PULSED DRAIN CURRENT @ T _C = 25°C	I _{DM}	-	-	110	Amps(pk)
OPERATING AND STORAGE TEMPERATURE	T_{OP}/T_{STG}	-55	-	+175	°C
TERMAL RESISTANCE JUNCTION TO CASE	$R_{\theta JC}$	-	-	1.32	°C/W
TOTAL DEVICE DISSIPATION @ T _C = 25°C	P_{D}	-	-	110	Watts

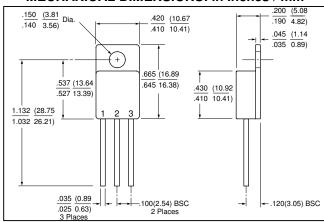
ELECTRICAL CHARACTERISTICS

DRAIN TO SOURCE BREAKDOWN VOLTAGE	BV _{DSS}	60	-	-	Volts
$V_{GS} = 0V, I_D = 250$	μΑ				
GATE THRESHOLD VOLTAGE V _{DS} = V _{GS} , I _D = 250	μA $V_{GS(th)}$	1.0	-	2.0	Volts
DRAIN TO SOURCE ON STATE RESISTANCE					
$V_{GS} = 5.0 Vdc, I_D = 18$	20(0.1)	-	-	0.055	Ω
$V_{GS} = 4.0 \text{Vdc} I_D = 18$	5A			0.075	
ZERO GATE VOLTAGE DRAIN CURRENT		-	-		
$V_{DS} = Max. Rating, V_{GS} = 0V$				25	μΑ
$V_{DS} = 0.8xMax. Rat$	-				
$V_{GS} = 0 V dc, T_{J} = 150$				250	
GATE TO BODY LEAKAGE CURRENT $V_{GS} = \pm 20V$	dc, I _{GSS}	-	-	±100	nA
TOTAL GATE CHARGE $V_{GS} = 5.0 \text{ V}$		-	-	35	nC
GATE TO SOURCE CHARGE $V_{DS} = 48$	Q_{gs}			7.1	
GATE TO DRAIN CHARGE $I_D = 3$	DA Q _{gd}			25	
TURN ON DELAY TIME $V_{DD} = 30$		-	14	-	nsec
RISE TIME $I_D = 30$			170		
TURN OFF DELAY TIME $R_G = 6$.	` '		30		
FALL TIME $V_{GS} = 5$.			56		
FORWARD VOLTAGE $T_J = 25^{\circ}C$, $I_S = 30A$, $V_{GS} = 0V$	V_{SD}	-	-	1.6	Volts
REVERSE RECOVERY TIME $I_F = 30$		-	120	180	nsec
REVERSE RECOVERY CHARGE di/dt ≤ 100A/µse	ec,				
INPUT CAPACITANCE $V_{DS} = 25 \text{ V}$	dc, C _{iss}	-	1600	-	pF
OUTPUT CAPACITANCE $V_{GS} = 0 \text{ Volume}$	dc, C _{oss}		660		
REVERSE TRANSFER CAPACITANCE f = 1 M	Hz C _{rss}		170		

^{*} Current is limited by package

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MECHANICAL DIMENSIONS: in Inches / mm



TO-257

PINOUT TABLE

DEVICE TYPE	PIN 1	PIN 2	PIN 3
N CHANNEL MOSFET IN A	DRAIN	SOURCE	GATE
TO-257 PACKAGE			



TECHNICAL DATA

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